AlphaPC64 Motherboard

User's Manual

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About This Manual

This manual describes Digital's AlphaPC64 motherboard, a module for computing systems based on the Alpha 21064A microprocessor and the DECchip 21072 chipset.

Audience

This guide is intended for users of the AlphaPC64 to assist them in installing the board and populating it with memory modules and peripheral cards.

Scope

This guide describes the features, configuration, and installation of the AlphaPC64. This guide does not include specific bus specifications (for example, PCI or ISA buses). Additional information is available in the appropriate vendor and IEEE specifications. See Appendix B for information about how to obtain additional technical support and how to order additional documentation.

Content

This guide contains the following chapters and appendixes:

- Chapter 1, AlphaPC64 Introduction, is an overview of the AlphaPC64, including its components, uses, and features.
- Chapter 2, System Jumpers and Connectors, describes the user environment configuration; board connectors and functions; jumper functions; and identifies jumper and connector locations.
- Chapter 3, Starting and Using the AlphaPC64, lists additional hardware and software requirements, provides information on how to configure the hardware and software, and describes the board startup procedures.
- Chapter 4, Functional Elements, describes some of the functional elements of the AlphaPC64, such as, interrupt assignments, flash ROM contents, and power distribution.

- Chapter 5, Board Requirements and Parameters, describes the AlphaPC64 power and environmental requirements, and identifies major board components.
- Appendix A, Supporting Vendor Products, lists suggested vendor sources for supporting components, such as, power supply, SIMMs, enclosure, and so forth.
- Appendix B, Technical Support and Ordering Information, describes how to obtain Digital Semiconductor information and technical support, and how to order Digital Semiconductor products and associated literature.
- Appendix C, Warranty Registration Information, provides information on how to register your AlphaPC64 motherboard and be notified of changes and updates.

Document Conventions

This section provides the conventions used in this document.

Caution: Cautions indicate potential damage to equipment or data.

Note: Notes provide additional information.

Numbering: All numbers are decimal or hexadecimal unless otherwise indicated. In case of ambiguity, a subscript indicates the radix of nondecimal numbers. For example, 19 is a decimal number, but 19_{16} and 19A are hexadecimal numbers.

Extents: Extents are specified by a single number, or a pair of numbers in angle brackets (< >) separated by a colon (:) and are inclusive. For example, bits <7:3> specify an extent including bits 7, 6, 5, 4, and 3. Multiple bit fields are shown as extents.

Register Figures: Register figures have bit and field position numbering starting at the right (low-order) and increasing to the left (high-order).

Signal Names: Signal names in text are printed in boldface lowercase type. For example, "... bits **data<127:0>** are delivered to the Bcache SIMM connectors ..."

AlphaPC64 Introduction

This chapter provides an overview of the AlphaPC64, its components, features, and uses.

1.1 The AlphaPC64 Motherboard

The AlphaPC64 Motherboard (AlphaPC64) is a module for computing systems, based on the Alpha 21064A microprocessor and the DECchip 21072 chipset. The AlphaPC64 runs the Windows NT operating system. For information on Digital UNIX or OpenVMS operating system support, contact your local distributor or your Digital sales representative.

1.2 System Components and Features

The AlphaPC64 is implemented in industry-standard parts and uses a 21064A microprocessor (CPU) running at 200 MHz to 275 MHz. The functional components are shown in Figure 1-1 and are introduced in the following subsections.

1.2.1 Memory Subsystem

The AlphaPC64 memory subsystem supports DRAM memory arrays of 16MB to 512MB with a 128-bit data bus. The memory is contained in two banks of four commodity single inline memory modules (SIMMs). Each SIMM is 36 bits wide, with 32 data bits, 1 parity bit, and 3 unused bits with 70-ns or less access. Figure 1–2 shows the maximum and minimum SIMM bank layouts. The following SIMM sizes are supported:

1M x 36 $2M \times 36$ 4M x 36 8M x 36 16M x 36

Figure 1-1 AlphaPC64 Functional Block Diagram

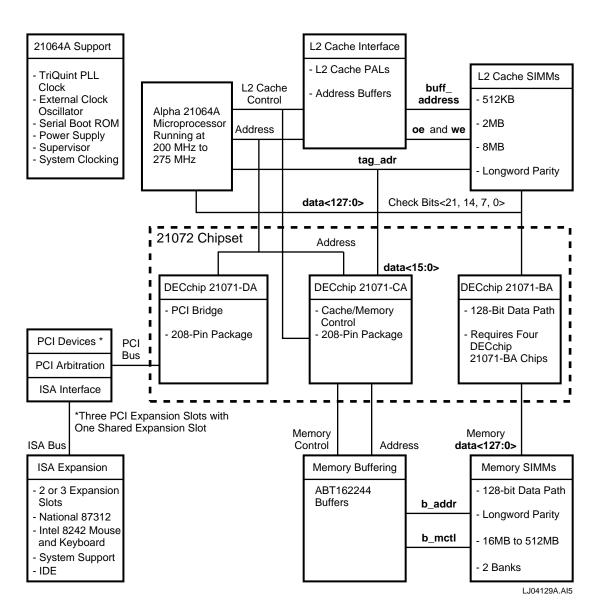
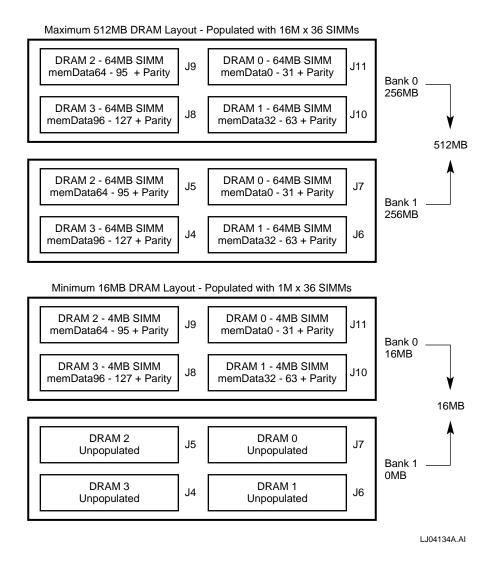


Figure 1–2 Maximum and Minimum SIMM Bank Layouts



1.2.2 DECchip 21072 Support Chipset

The 21064A is supported by a DECchip 21072 ASIC chipset (21072), with a 128-bit memory interface. The chipset consists of the following three chips:

- DECchip 21071-CA (21071-CA) provides the interface from the CPU to cache and main memory, and includes the cache and memory controller.
- DECchip 21071-BA (21071-BA) provides a 32-bit data path from the CPU to memory and I/O. Four chips provide the 128-bit interface.
- DECchip 21071-DA (21071-DA) provides an interface from the CPU to the peripheral component interconnect (PCI) bus.

The chipset includes the majority of functions required for a high-performance PC or workstation, requiring minimum discrete logic on the motherboard. The chipset provides flexible and generic functions to allow its use in a wide range of systems.

For more information on the DECchip 21072 chipset, see the DECchip 21071 and DECchip 21072 Core Logic Chipsets Data Sheet.

1.2.3 PAL Control Set

The AlphaPC64 contains a 4-PAL control set and includes the following:

- Two 16V8-5 PALs provide L2 cache output-enable and write-enable functions.
- One 22V10-25 PAL provides interrupt address decode functions and utility bus (Ubus) control.
- One MACH210-20 PAL provides the PCI and ISA interrupts.

1.2.4 Level 2 Cache Subsystem Overview

The external level 2 (L2) cache subsystem supports 512KB, 2MB, or 8MB cache sizes by using a 128-bit data bus. The L2 cache size can be reconfigured through onboard hardware and software jumpers.

The AlphaPC64 supports the L2 cache SIMM sizes shown in Table 1–1. SIMM types currently available and supported are 512KB @15 ns and 2MB @12 ns. Two SIMMs are required per system. See Appendix A for ordering information.

Table 1-1 L2 Cache SIMM Sizes

L2 Cache Size	Static RAM Access Times	
512KB	6 ns, 8 ns, 10 ns, 12 ns, 15 ns	
2MB	6 ns, 8 ns, 10 ns, 12 ns, 15 ns	
8MB	6 ns, 8 ns, 10 ns, 12 ns, 15 ns	

1.2.5 Clock Subsystem Overview

The clock subsystem provides clocks to the 21072 chipset and PCI devices. Two oscillators provide clocks for the ISA and combination chip functions.

1.2.6 PCI Interface Overview

The PCI interface provides a selectable PCI speed between 25 MHz and 33 MHz (based on the 21064A clock divisor). An Intel 82378ZB Saturn IO (SIO) chip provides a PCI-to-ISA bridge.

The PCI has three dedicated slots and one shared slot with the ISA.

1.2.7 ISA Interface Overview

The ISA provides an expansion bus and the following system support functions:

- Mouse and keyboard controller functions provided through an Intel 8242
- A National 87312 chip used as the combination chip providing a diskette controller; two universal asynchronous receiver-transmitters (UARTs); an integrated device electronics (IDE) interface; a bidirectional parallel port; and an interface to the utility bus (Ubus) for ISA interrupts and jumper
- A time-of-year (TOY) function provided by a Dallas Semiconductor DS1287
- A 1MB flash ROM memory using the Intel 28F008SA chip

The ISA has two dedicated expansion slots and one shared expansion slot with the PCI.

1.2.8 Software Support

Software support includes an industry-standard, 1MB flash ROM containing Windows NT ARC firmware and debug monitor code. The debug monitor allows you to:

- Download files through serial port, I/O diskette, and optional Ethernet port.
- Load data from the flash ROM through the debug monitor.
- Examine and deposit the AlphaPC64 system register, 21064A internal processor registers (IPRs), and I/O mapped registers.
- Examine and modify DRAM and I/O mapped memory.
- Disassemble CPU instructions in memory.
- Transfer control to programs in memory.
- Perform native debugging, including breakpoints and single stepping.
- Perform full source-level debugging, using DECladebug running on a host communicating through an Ethernet connection.

Development code can be generated on a host system and loaded into the AlphaPC64 through the serial line, optional Ethernet port, diskette, or flash ROM. Full design database and user documentation are provided.

A serial ROM (SROM) contains the 21064A initialization code. When reset is deasserted, the contents of the SROM are read into the Icache and are executed to perform initialization. During initialization, code is loaded from the flash ROM to memory. Following initialization, control is transferred to the code in memory.

1.2.9 Component Layout

Figure 1–3 shows the AlphaPC64 board component layout and dimensions.

1.2.10 System Summary

Table 1–2 lists the physical, performance, and operating characteristics of the AlphaPC64 motherboard.

Figure 1–3 AlphaPC64 Component Layout and Board Dimensions

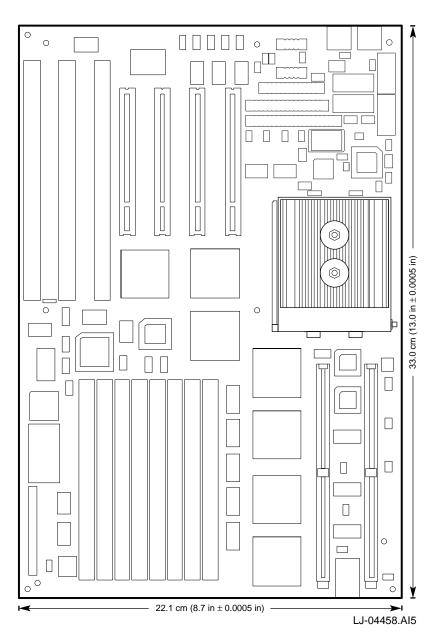


Table 1-2 AlphaPC64 Summary

Characteristic	Description				
Operating Systems					
Supported operating systems	Microsoft Windows NT. For information on Digital UNIX or OpenVMS operating system support, see your local distributor or your Digital sales representative.				
System Characteristics					
CPU and clock speed	Alpha 21064A a	t 200 MHz, 23	3 MHz, or 275 MHz		
CPU upgradable	ZIF socket for A	lpha 21064A u	pgrade		
Instruction issue	Up to 2 instruct	ions issued per	clock cycle		
Word size	64 bits				
Address size	34-bit physical a	address, 43-bit	virtual address		
Floating-point format	VAX (F and G) a	and IEEE (S ar	nd T) data types		
Memory (DRAM) ¹	Minimum DRAM 16MB plus parity Maximum DRAM 512MB plus parity				
Memory (ROM)	1MB flash ROM				
External L2 cache	Configurable for 512KB, 2MB, 8MB (128-bit data)				
Memory bus width	128 bits plus parity				
Performance metrics Alpha 21064A running at 275 MHz	Cache	SPECint92	SPECfp92		
	512KB @15 ns	176	217		
	2MB @12 ns	193	259		
	2MB @8 ns	205	272		

¹Minimum DRAM recommended: 16MB for Windows NT 32MB for Digital UNIX 32MB for OpenVMS

Table 1–2 (Cont.) AlphaPC64 Summary

Characteristic	Description			
Graphics				
Graphics options	Refer to the Microsoft <i>Hardware Compatibility List</i> for Windows NT to determine which graphics cards are supported. See Section B.4 for information on how to obtain the listing.			
Input/Output				
Input device interfaces	PS/2 style keyboard and mouse			
Serial	Two RS423-compatible (9-position) serial communications ports			
Parallel	One parallel (Centronics compatible) communications port			
Bus options	Total of 6 option slots			
PCI bus	Supports four 5-V/32-bit PCI option slots at 33 MHz maximum-one long and three short cards			
ISA bus	Supports three 16-bit ISA option slots			
IDE	One IDE interface supporting up to 2 drives			
Diskette	One 82077-compatible diskette controller supporting up to 2 drives with 1.44MB and 2.88MB formats			
Physical Characteristics				
Form factor	Baby-AT-size system board			
Width/depth	22.1 cm (8.7 in) \times 33.0 cm (13.0 in)			
Weight	840 grams (1.85 lb) with high-profile heat sink			
	(continued on next page)			

Table 1–2 (Cont.) AlphaPC64 Summary

Characteristic	Description						
Environmental Characte	Environmental Characteristics (Operating)						
Temperature	10°C to 40°C (50°F to 104°F)						
Temperature change rate (maximum)	20°C/hr (36°F/hr)						
Relative humidity Maximum wet bulb Minimum dew point	10%–90% noncondensing 32°C (90°F) 2°C (36°F)						
EMC compliance	Compliance certification is the responsibility of the system integrator. The AlphaPC64 was tested in industry-representative enclosures to prove feasibility of emissions compliance.						
Shock and vibration	Passing of shock and vibration tests is dependent on the method used to mount the system board, the design of the enclosure, and how the enclosure is supported. Testing is the responsibility of the system integrator.						

System Jumpers and Connectors

The AlphaPC64 uses jumpers to implement variations in clock frequency and L2 cache size and speed. These jumpers must be configured for the user's environment. Onboard connectors are provided for the I/O, memory SIMMs, serial and parallel peripherals, integrated device electronics (IDE) devices, and L2 cache SIMMs.

After the module is configured, you can apply power and run the debug monitor. The debug monitor and its commands are described in the Alpha Microprocessors Evaluation Board Debug Monitor User's Guide. Appendix B provides information about other software design tools.

2.1 Configuration Jumpers

The software and hardware configuration jumpers are identified in Figures 2-1 and 2-2, and are described in Tables 2-1 and 2-2.

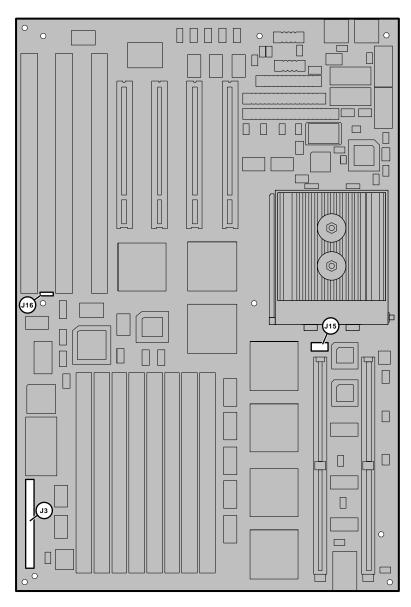
2.1.1 Software Configuration Jumpers

The software configuration jumpers are completely programmable. Each jumper position is described in Table 2–1.

The SROM code defines the software configuration jumpers **sp_bit<7:0>**, as shown in Figure 2–2 (see also Chapter 4).

The board ships with the jumpers listed in Tables 2-1 and 2-2 in the default position.

Figure 2–1 AlphaPC64 Board Jumpers



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Figure 2-2 J3 Jumpers/Connectors

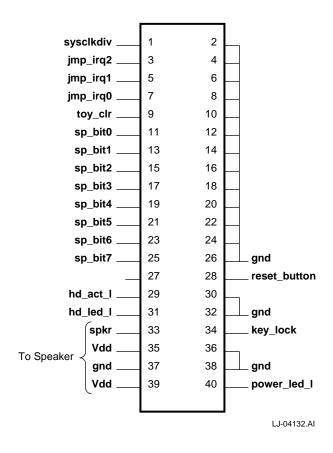


Table 2-1 Jumper Position Descriptions

Select Bit	Register Bit Name	Function		
sp_bit7	BOOT_OPTION	Jumper out—Boot first image in flash ROM. Jumper in (default)—Boot one of several altern images in flash ROM as specified by NVRAM location 3F in TOY RAM. See Section 4.4.		
sp_bit6	MINI_DEBUG	Jumper out (default)—Boot selected image in flash ROM. Jumper in—Trap to SROM debug port (J2).		
sp_bit<5:3>	BC_SPEED<2:0>	L2 cache speed selection is shown here.		
		BC SPEED		

_	BC_SPE		
<2> J3-21	<1> J3-19	<0> J3-17	L2 Cache Period
In ¹	In	In	Reserved
In	In	Out^2	6 ns
In	Out	In	8 ns
In	Out	Out	10 ns
Out	In	In	12 ns (default for 21A02–A3 and 21A02–A
Out	In	Out	15 ns (default for 21A02–A5)
Out	Out	In	Reserved
Out	Out	Out	Reserved

¹Jumper in (logical 0)

²Jumper out (logical 1)

Table 2–1 (Cont.) Jumper Position Descriptions

Select Bit	Register Bit Name	Function	ı			
sp_bit<2:0>	BC_SIZE<2:0>	L2 cache	L2 cache size selection is shown here.			
			BC_SIZ	E		
		<2> J3-15	<1> J3-13	<0> J3-11	L2 Cache Size	
		In ¹	In	In	Disables L2 cache	
		In	In	Out ²	512KB (default for 21A02-A5)	
		In	Out	In	1MB	
		In	Out	Out	2MB (default for 21A02–A3 and 21A02–A3	
		Out	In	In	4MB	
		Out	In	Out	8MB	
		Out	Out	In	Reserved	
		Out	Out	Out	Reserved	

¹Jumper in (logical 0)

²Jumper out (logical 1)

2.1.2 Hardware Configuration Jumpers

Hardware configuration jumpers are shown in Figure 2-1 and are described in **Table 2–2.**

Table 2-2 AlphaPC64 Board Jumpers

Connector	Pins	Descript	ion			
		L2 Cache Address Lines				
J15	4	Adr<22:	1 9 > L2 cac			
		J15-1 Adr19	J15-2 Adr20	J15-3 Adr21	J15-4 Adr22	Size
		Out ²	Out	Out	Out	512KB (default for 21A02-A5)
		In^1	Out	Out	Out	1MB
		In	In	Out	Out	2MB (default for 21A02–A3 and 21A02–A4)
		In	In	In	Out	4MB
		In	In	In	In	8MB
			Flash	n ROM		
J16	3	Jumper	from pin 1 from pin 2	to pin 2 dis		tor. ROM update. n ROM update

¹Jumper in (logical 0)

²Jumper out (logical 1)

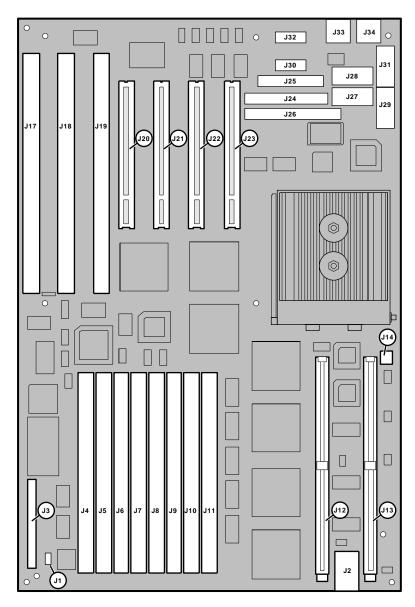
Table 2-2 (Cont.) AlphaPC64 Board Jumpers

Connector	Pins	Description					
		Syste	m Clock Fun	ctions			
J3	4	21064A CPU clock divisor selection.					
		J3-1 sysclkdiv	J3-3 jmp_irq2	J3-5 jmp_irq1	J3-7 jmp_irq0	Divisor	
		In	In	In	In	2	
		In	In	In	Out	3	
		In	In	Out	In	4	
		In	In	Out	Out	5	
		In	Out	In	In	6	
		Divisor 6 is used for 200 MHz.					
		In	Out	In	Out	7	
			Divisor 7 i	is used for 2	233 MHz.		
		In	Out	Out	In	8	
		In	Out	Out	Out	9	
		Divisor 9 is used for 275 MHz (default).					
		Out	In	In	In	10	
		Out	In	In	Out	11	
		Out	In	Out	In	12	
		Out	In	Out	Out	13	
		Out	Out	In	In	14	
		Out	Out	In	Out	15	
		Out	Out	Out	In	16	
		Out	Out	Out	Out	17	

2.2 AlphaPC64 Board Connectors

The module connectors are shown in Figure 2–3 and are described in Table 2–3.

Figure 2–3 AlphaPC64 Board Connectors



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Table 2-3 Module Connector Descriptions

Connector	Pins	Description
		PCI Connectors
J23	124	PCI expansion connector 3
J22	124	PCI expansion connector 2
J21	124	PCI expansion connector 1
J20	124	PCI expansion connector 0
		ISA Connectors
J19	98	ISA expansion connector 2
J18	98	ISA expansion connector 1
J17	98	ISA expansion connector 0
	L	.2 Cache SIMMs Connectors
J13	160	L2 cache SIMMs connector 1, data<127:64>
J12	160	L2 cache SIMMs connector 0, data<63:00>
		Keyboard Connector
J33	6	Keyboard connector
		Mouse Connector
J34	6	Mouse connector

Table 2-3 (Cont.) Module Connector Descriptions

Connector	Pins	Description
		Memory SIMMs
J11	72	Bank 0, DRAM 0 SIMM
J10	72	Bank 0, DRAM 1 SIMM
J9	72	Bank 0, DRAM 2 SIMM
Ј8	72	Bank 0, DRAM 3 SIMM
J7	72	Bank 1, DRAM 0 SIMM
J6	72	Bank 1, DRAM 1 SIMM
J5	72	Bank 1, DRAM 2 SIMM
J4	72	Bank 1, DRAM 3 SIMM
		SROM Test
J2	6	SROM test data serial port input connector
		Note: This connector can be used as a terminal port for the Mini-Debugger.
]	National 87312 Connectors
J25	26	Combination chip parallel port connector
J26	40	IDE supports two devices.
J32	10	Combination chip serial communication port 1 (COM1) connector
		Note: This connector can be used as a terminal port for the Debug Monitor.
J30	10	Combination chip serial communication port 2 (COM2) connector
J24	34	Combination chip diskette drive connector

Table 2-3 (Cont.) Module Connector Descriptions

Connector	Pins	Description		
		Powe	er Connectors	
J27	6	Module power connector (GND, +3.3 V)		
		Pin	Voltage/Signal	
		1	Ground	
		2	Ground	
		3	Ground	
		4	+3.3 V	
		5	+3.3 V	
		6	+3.3 V	
J28	6	Module power connector (+3.3 V, GND)		
		Pin	Voltage/Signal	
		1	+3.3 V	
		2	+3.3 V	
		3	+3.3 V	
		4	Ground	
		5	Ground	
		6	Ground	

Table 2-3 (Cont.) Module Connector Descriptions

Connector	Pins	Description		
J29	6	Module power connector (GND, -5 V, $+5$ V [Vd		
		Pin	Voltage/Signal	
		1	Ground	
		2	Ground	
		3	-5 V	
		4	Vdd	
		5	Vdd	
		6	Vdd	
J31	6	Module power connector (GND, +12 V, -12 V, +5 V $[Vdd]$, $\mathbf{p_dcok}$)		
		Pin	Voltage/Signal	
		1	p_dcok	
		2	Vdd	
		3	+12 V	
		4	-12 V	
		5	Ground	
		6	Ground	
		supplie	Power for the AlphaPC64 is provided by a usered, standard PC power supply that includes lc. Digital does not provide this power supply.	
J14	3	CPU fan power and sensor		
		Caution: Fan sensor required		
		if the a	n <i>must</i> have a built-in sensor that drives a signal airflow stops. The sensor is connected to J14. The oplied with the AlphaPC64 includes an airflow	
			(continued on next page)	

Table 2-3 (Cont.) Module Connector Descriptions

Connector	Pins	Description		
Enclosure Fan				
J1	3	Enclosure fan connector (+12 V, GND)		
		System Reset		
J3 (Pins 28, 30)	2	System reset switch connector		
		Speaker Connector		
J3 (Pins 33, 35, 37, 39)	4	Speaker should be connected to pins 33, 35, 37, and 39.		

Starting and Using the AlphaPC64

This chapter lists hardware, software, and accessories that users must obtain to completely furnish a functioning computer system. The chapter then describes how to configure the hardware and software. Finally, the chapter describes how to start and use the AlphaPC64.

3.1 Hardware Requirements

Before turning on the power to your AlphaPC64, you must provide the following components in addition to those supplied with your board. The components listed here round out the complement of parts needed to run the Windows NT operating system on the AlphaPC64 motherboard.

- An Alpha 21064A microprocessor (200-MHz, 233-MHz, or 275-MHz speed).
- If a 200-MHz or 233-MHz microprocessor is used, the oscillator and PLL must be changed. Refer to Appendix A for part numbers and sources. The board ships with parts to complement a 275-MHz microprocessor.
- Four or eight, 72-pin, 36-bit, 5-V, DRAM SIMM memory modules (connectors J4 through J11). SIMMs must be installed in groups of four consisting of identical devices. Digital recommends that all SIMMs be purchased from the same vendor.
- Two Alpha L2 cache SRAM SIMMs (connectors J12 and J13). Part numbers for 512KB or 2MB cache sizes are listed in Appendix A.
- An industry-standard PC power supply that includes a 3.3-V dc output, rated at a minimum of 275 W (refer to Appendix A).
- A PS/2 compatible 101-key keyboard.
- A PS/2 compatible mouse.
- A supported PCI or ISA bus graphics card, cables, and a compatible monitor.
- A supported PCI bus SCSI controller card and cables.

3.1 Hardware Requirements

- A SCSI CD-ROM drive.
- An IDE or SCSI hard drive.
- A 3.5-in diskette drive and cable.
- A 9-pin serial line cable.
- A terminal or a serial line connection to a host system with appropriate

Refer to the Alpha Microprocessors Evaluation Board Windows NT 3.51 Installation Guide provided in the AlphaPC64 Windows NT 3.51 Installation Kit and the Hardware Compatibility List for Windows NT to determine which SCSI controllers and graphics cards are supported.

For more information about hardware requirements and for the location of board connectors and jumpers, see Chapter 2.

3.2 Software Requirements

The following software media is required to install and run the Windows NT operating system:

- A Windows NT 3.5 or 3.51 CD-ROM
- An AlphaPC64 Windows NT 3.5 or 3.51 installation diskette

3.3 Hardware Configuration

Once you have acquired the necessary hardware, it must be assembled into a system. This section lists the necessary steps. The system does not have to be assembled in the order presented. However, if you are installing the motherboard into an enclosure, Digital recommends that you install the microprocessor and heat sink first.

Caution: Static-Sensitive Component
Due to the sensitive nature of electronic components to static electricity,
Digital strongly advises that anyone handling the Alpha 21064A wear
a properly grounded antistatic wrist strap. Use of antistatic mats,
ESD approved workstation, or exercising other good ESD practices is
recommended.

3.3 Hardware Configuration

- 1. Install the Alpha 21064A microprocessor in ZIF socket U36.
 - a. Observe antistatic precautions.
 - b. Lift the ZIF socket actuator handle to a full 90° angle.
 - c. Make sure that all the pins on the Alpha 21064A are straight.
 - d. The ZIF socket and Alpha 21064A are keyed to allow for proper installation. Align the Alpha 21064A, with its missing AD01 pin, with the corresponding plugged AD01 position on the ZIF socket. Gently lower into position.
 - e. Close the ZIF socket actuator handle to its locked position.
- 2. If you are installing a 275-MHz microprocessor, you do not need to change any other components or associated jumper settings.
 - If you are installing a 200-MHz or 233-MHz microprocessor, you must replace oscillator U41 and PLL U40 with the appropriate parts. Refer to Appendix A for part listings. You must also reconfigure the clock divisor jumpers on header J3, as described in Table 2–2.
- 3. Install the heat sink and heat sink fan as directed in the following steps. Heat sinks and accompanying fans are available from Digital in kit form, or from recommended vendors as kits or component piece parts.

A TS30 manual nut/torque driver with the following attachments is required to affix the heat sink and fan to an Alpha 21064A:

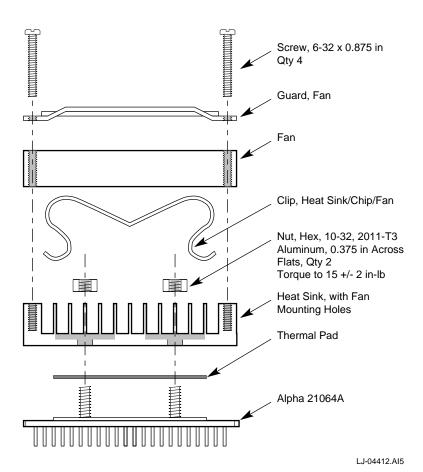
- 1/4-in hex bit
- 3/8-in socket with 1/4-in hex drive
- #2 Phillips screwdriver bit

Note	
Install the heat sink only after the Alpha to the board ZIF socket.	21064A has been assembled

3.3 Hardware Configuration

Refer to Figure 3–1 for heat sink and fan assembly details.

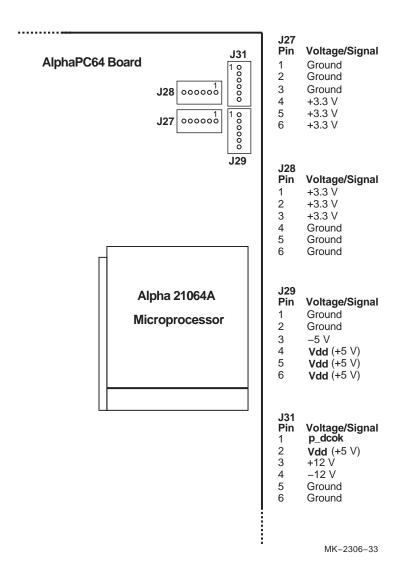
Figure 3-1 Fan/Heat Sink Assembly



- a. Put the GRAFOIL thermal pad in place. The GRAFOIL pad is used to improve the thermal conductivity between the chip package and the heat sink by replacing micro air pockets with a less insulative material. Perform the following steps to position the GRAFOIL pad:
 - 1) Perform a visual inspection of the package slug to ensure that it is free of contamination.
 - Wearing clean gloves, pick up the GRAFOIL pad. Do not do this with bare hands because skin oils can be transferred to the pad.
 - 3) Place the GRAFOIL pad on the gold-plated slug surface and align it with the threaded studs.
- b. Attach the microprocessor heat sink. The heat sink material is clear anodized, hot-water-sealed, 6061-T6 aluminum. The nut material is 2011-T3 aluminum (this grade is critical). Perform the following steps to attach the heat sink:
 - 1) Observe antistatic precautions.
 - 2) Align the heat sink holes with the threaded studs on the ceramic package.
 - 3) Handle the heat sink by the edges and lower it on to the chip package, taking care not to damage the stud threads.
 - 4) Set a calibrated torque driver to 15 in-lb, ± 2 in-lb, (1.7 N m, ± 0.2 N m). The torque driver should have a mounted 3/8-in socket.
 - 5) Insert a nut into the 3/8-in socket, place on one of the studs, and tighten to the specified torque. Repeat for second nut.
 - 6) If the sink/chip/fan clip is used, install it properly by positioning it over the assembly and hooking its ends around the ZIF socket retainers.

- c. Perform the following steps to attach the heat sink fan assembly:
 - 1) Place the fan assembly on top of the heat sink, aligning the fan mounting holes with the corresponding threaded heat sink holes. Align the fan so that the fan power/sensor wires exit the fan closest to connector J14 (see Figure 2-3). Fan airflow must be directed into the heat sink (fan label facing down toward the heat sink).
 - 2) Place the fan guard on top of the fan. Orient the guard so that the corner mounting areas lay flush against the heat sink.
 - 3) Secure the fan and fan guard to the heat sink with four $6-32 \times 0.875$ -in screws.
 - 4) Plug the fan power/sensor cable into connector J14 (see Figure 2-3).
- 4. Install the two L2 cache SRAM SIMMs into sockets J12 and J13. Refer to Table 2-3 for socket locations.
- 5. Install either four or eight system memory DRAM SIMMs. Refer to Section 1.2.1 for configuration information and Table 2-3 for socket locations.
 - a. **Observe antistatic precautions.** Handle SIMMs at the edges only to prevent damage.
 - b. SIMMs must be installed in groups of four consisting of identical devices.
 - c. Hold the SIMM at an angle with the notch facing the key in the socket.
 - d. Firmly push the module into the connector and stand the module upright.
 - e. Make sure that the SIMM snaps into the metal locking clips on both ends.
- 6. If you intend to mount the motherboard in a system enclosure, do so now. Install the power supply into the enclosure first, then the motherboard. Appendix A lists a suggested enclosure and a suggested power supply. The enclosure you use should be able to accept a standard baby-AT-size motherboard.
- 7. Connect the power supply to the motherboard, as shown in Figure 3–2, with standard power to J29 and J31 and with 3.3-V dc power to J27 and J28.

Figure 3-2 AlphaPC64 Power Connectors



- 8. If you are using an enclosure, mount the 3.5-in diskette drive, hard drive, and CD-ROM drive. Refer to the manufacturer's instructions for installing these devices.
- 9. Connect the 3.5-in diskette drive. The 34-pin diskette drive cable goes from connector J24 on your AlphaPC64 to the diskette drive. The drive should be connected at the very end of the cable closest to the twist in the cable. Make sure to insert the connector in the proper orientation so that pin 1 on the cable matches pin 1 on the board header (as indicated on the board). Attach a power connector to the drive.
- 10. Attach a SCSI cable to the SCSI controller card and install the card in a free PCI or ISA connector, depending on the card you are using. Attach the opposite end of the cable to the CD-ROM drive. If you will be using an IDE hard drive, attach a SCSI bus terminator at the CD-ROM drive. If you will be using a SCSI hard drive, daisy-chain a SCSI cable from the CD-ROM drive to the hard drive. Attach a SCSI bus terminator to the hard drive. Verify that a unique SCSI ID is assigned to each device you attach to the SCSI bus.
- 11. If you will be using an IDE hard drive, attach your IDE cable to connector J26 in the proper orientation and at the opposite end to your hard drive. The disk should be configured as the primary device on the IDE bus. Refer to the manufacturer's instructions for setting up the hard drive.
- 12. Install the graphics card into either a PCI or ISA connector, depending on the card you are using. Connect the graphics card to a compatible monitor, following the graphics card manufacturer's instructions.
- 13. Connect the keyboard cable to connector J33.
- 14. Connect the mouse cable to connector J34.
- 15. Connect a 9-pin serial port adapter cable to the COM1 connector at J32. Insert the connector in the proper orientation, so that pin 1 on the cable matches pin 1 on the board header (as indicated on the board).
- 16. Connect your host system or terminal to the COM1 port by using an appropriate cable arrangement. Set the host system communications port or terminal to 9600 baud, 8 data bits, 1 stop bit, no parity.
- 17. Connect miscellaneous items such as, enclosure fans, reset button, speaker, power indicator, hard drive active indicator (if using an IDE drive), keyboard lock switch, and so forth.

3.4 Software Configuration

Two firmware programs have been loaded into the AlphaPC64 1MB flash ROM. They are the debug monitor and the Windows NT ARC firmware. The debug monitor is a serial line monitor program used to perform software and hardware debug functions. The Windows NT ARC firmware is used to load and boot Windows NT. The AlphaPC64 system has been configured to start the Windows NT ARC firmware by default.

The serial ROM firmware uses a value stored in the nonvolatile RAM of the real-time clock to determine which firmware image to load. Once the Windows NT ARC firmware is running, you can switch to the debug monitor firmware.

3.4.1 Starting Windows NT ARC Firmware

Start the Windows NT ARC firmware using the following procedure:

- 1. Verify that the jumper from J16-2 to J16-3 is inserted, allowing the flash ROM to be written. If the Windows NT ARC firmware is unable to write to flash ROM, it prints the device error message and stops.
- 2. Verify that the jumper from J3–25/26 is installed (see SP7 on the board). The presence of the jumper at J3–25/26 forces the serial ROM firmware to load the alternate image selected by the value in the nonvolatile TOY RAM. The absence of this jumper overrides the value stored in the TOY RAM and causes the first image, the debug monitor, to be loaded.
- 3. Turn on the power to the AlphaPC64. After the power-up diagnostics are run, the ARC console boot menu appears on the graphics display.
 If the ARC console boot menu does not appear, check the output of COM1 for error messages and review your hardware configuration.

You are ready for software installation. Refer to the *Alpha Microprocessors Evaluation Board Windows NT 3.51 Installation Guide* for instructions.

3.4.2 Going to the Debug Monitor from Windows NT ARC Firmware

You may use either of these two methods to access the debug monitor from the Windows NT ARC firmware.

- A. Use the ARC firmware menus to choose the debug monitor.
 - 1. At the Boot menu, choose Supplementary menu....
 - 2. At the Supplementary menu, choose **Setup the system...**.
 - 3. At the Setup the system menu, choose **Machine specific setup...**.
 - 4. At the Machine specific setup menu, choose **Debug Monitor**.

3.4 Software Configuration

- 5. Turn off the power to the AlphaPC64, and then turn the power back
- B. Turn off the power to the AlphaPC64, remove the jumper from J3-25/26 (SP7 on the board), and then turn on the power to the AlphaPC64.

3.4.3 Returning to Windows NT ARC Firmware from the Debug Monitor

The following methods may be used to return to the Windows NT ARC firmware from the debug monitor.

A. If you used item A in Section 3.4.2 to enter the debug monitor, then use this procedure to return to Windows NT ARC firmware.

The firmware contained in the the serial ROM on your AlphaPC64 determines which firmware image is loaded from the flash ROM at power-up. The serial ROM firmware uses a value stored in the nonvolatile RAM of the real-time clock to determine which firmware image to load. At this point, you want the serial ROM to load the Windows NT ARC firmware.

1. Use the following debug monitor commands to select Windows NT ARC firmware, by writing the value 1 to the TOY RAM, and to verify the selection:

```
AlphaPC64> bootopt nt
O/S type selected: "The Windows NT Operating System"
....Firmware type: "Windows NT Firmware"
AlphaPC64> bootopt
Predefined bootoptions are...
  "0" "Alpha Evaluation Board Debug Monitor" "DBM"
  "1" "The Windows NT Operating System" "NT"
  "2" "OpenVMS" "VMS"
  "3" "Digital UNIX" "UNIX"
O/S type selected: "The Windows NT Operating System"
....Firmware type: "Windows NT Firmware"
AlphaPC64>
```

- 2. Turn off the power to the AlphaPC64. Verify the presence of a jumper at J3-25/26 (see SP7 on the board).
- 3. Turn on the power to the AlphaPC64. After the power-up diagnostics are run, the ARC console boot menu appears on the graphics display.

3.4 Software Configuration

- B. If you used item B in Section 3.4.2 to enter the debug monitor, then use this procedure to return to Windows NT ARC firmware:
 - 1. Turn off the power to the AlphaPC64 and install the jumper at J3-25/26 (see SP7 on the board).
 - 2. Turn on the power to the AlphaPC64. After the power-up diagnostics are run, the ARC console boot menu appears on the graphics display. If the ARC console boot menu does not appear, check the output of COM1 for error messages and review your hardware configuration.

Functional Elements

This chapter describes some of the functional elements of the AlphaPC64. Information, such as bus timing and protocol, found in other specifications, data sheets, and reference documentation is not duplicated. Appendix B provides a list of supporting documents and order numbers.

Note

For a detailed description of the Alpha 21064A, refer to the Alpha 21064 and Alpha 21064A Microprocessors Hardware Reference Manual.

For detailed descriptions of chipset logic, operations, and transactions, refer to the DECchip 21071 and DECchip 21072 Core Logic Chipsets Data Sheet.

For details of the PCI interface, refer to the PCI System Design Guide and the PCI Local Bus Specification.

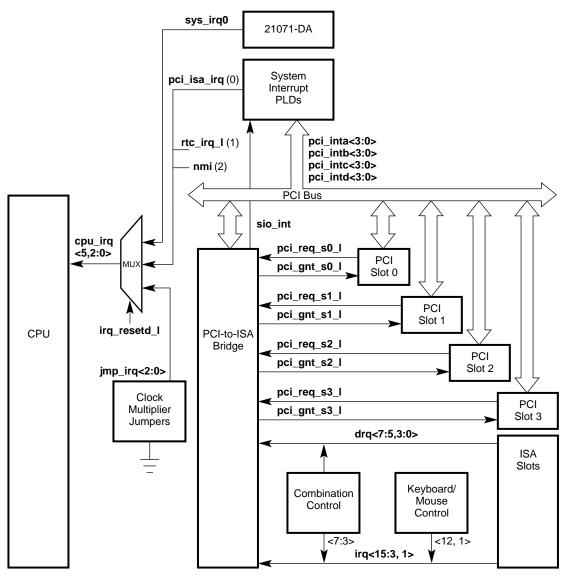
4.1 PCI Interrupts and Arbitration

The following subsections describe the PCI interrupt and arbitration (arbiter) logic.

4.1.1 System Interrupts

Figure 4–1 shows the AlphaPC64 interrupt logic. Interrupt logic is implemented in two programmable logic devices (PLDs), MACH210-20 and 22V10-25. The PLDs allow each PCI and PCI-to-ISA bridge chip interrupt to be individually masked. The PLDs also allow the current state of the interrupt lines to be read.

Figure 4–1 Interrupt Control and PCI Arbitration



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The AlphaPC64 interrupt controller has 17 interrupts: four from each of the four PCI slots (16) and one from the SIO bridge.

All PCI interrupts are combined in the PLD and drive a single output signal, **pci_isa_irq**. This signal drives CPU input **cpu_irq0** through a multiplexer. There is also a memory controller error interrupt and an I/O controller error interrupt within the CPU.

Table 4–1 lists the CPU interrupt assignment during normal operation.

Table 4-1 CPU Interrupt Assignment

Interrupt Source	CPU Interrupt	Description
pci_isa_irq	cpu_irq0	Combined output of the interrupt PLD
rtc_irq_l	cpu_irq1	Real-time clock interrupt from DS1287
nmi	cpu_irq2	Nonmaskable interrupt from the SIO bridge
_	cpu_irq3, cpu_irq4	Not used; tied to ground
sys_irq0	cpu_irq5	Hardware interrupt from the PCI host bridge (21071-CA)

Three jumpers (J3-3, J3-5, and J3-7) connect to one side of the multiplexer. The jumper configuration sets the CPU clock multiplier value through the **cpu_irq**n inputs during reset.

The ISA bus interrupt signals (irq0 through irq8 and irq12 through irq14) are all nested through the SIO and then into the CPU. The interrupt assignment is configurable but is normally used as follows:

Interrupt Level	Interrupt Source	
IRQ0	Interval timer	
IRQ1	Keyboard	
IRQ2	Chains interrupt from slave peripheral interrupt controller (PIC)	
IRQ3	8-bit ISA from serial port COM2	
IRQ4	8-bit ISA from serial port COM1	
IRQ5	8-bit ISA from parallel port (or irq7)	
IRQ6	8-bit ISA from diskette controller	
IRQ7	8-bit ISA from parallel port (or irq5)	
IRQ8	Unused (real-time clock internal to the SIO)	
IRQ9, IRQ10, IRQ11	16-bit ISA	
IRQ12	Mouse	
IRQ13	16-bit ISA	
IRQ14	IDE	
IRQ15	16-bit ISA	

The AlphaPC64 timer interrupt is generated by the real-time clock by means of cpu_irq1, rather than by the timer within the SIO, which would route the interrupt through the ISA bus interrupts.

Interrupt PLDs Function

The MACH210 PLD acts as an 8-bit I/O slave on the ISA bus at addresses 804h, 805h, and 806h. This is accomplished by a decode of the three ISA address bits **sa<2:0>** and the three **ecas_addr<2:0>** bits.

Each interrupt can be individually masked by setting the appropriate bit in the mask register. An interrupt is disabled by writing a 1 to the desired position in the mask register. An interrupt is enabled by writing a 0. For example, bit <7> set in interrupt mask register 1 indicates that the INTB2 interrupt is disabled. There are three mask registers located at ISA addresses 804h, 805h, and 806h.

An I/O read transaction at ISA addresses 804h, 805h, and 806h returns the state of the 17 PCI interrupts rather than the state of the masked interrupts. On read transactions, a 1 means that the interrupt source shown in Figure 4–2 has asserted its interrupt. The mask register can be updated by writing addresses 804h, 805h, or 806h. The mask register is write-only.

Figure 4-2 Interrupt and Interrupt Mask Registers

Interrupt and Interrupt Mask Register 1 (ISA Address 804h) 7 5 3 2 0 4 1 intb2 intb1 intb0 inta3 inta2 inta1 inta0 Interrupt and Interrupt Mask Register 2 (ISA Address 805h) 5 4 3 2 7 6 1 0 intd2 intd1 intd0 intc3 intc2 intc1 intc0 intb3

Interrupt and Interrupt Mask Register 3 (ISA Address 806h)

7	6	5	4	3	2	1	0
RAZ	intd3						

Notes: RAZ = Read-as-Zero, Read-Only Interrupt Mask Register Is Write-Only

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4.1.2 PCI/ISA Arbitration

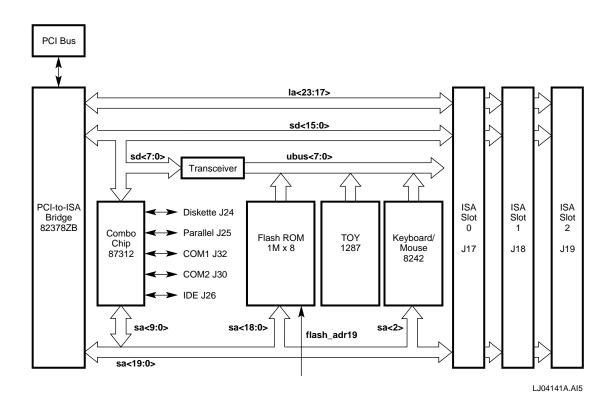
Arbitration logic is implemented in the Intel 82378ZB Saturn IO (SIO) chip. The arbitration scheme is flexible and software programmable. Refer to the Intel 82420/82430 PCIset ISA and EISA Bridges document for more information about programmable arbitration.

4.2 ISA Devices

4.2 ISA Devices

Figure 4-3 shows the AlphaPC64 ISA bus implementation with peripheral devices and connectors. Also shown is the utility bus (Ubus) with system support devices.

Figure 4-3 ISA Devices



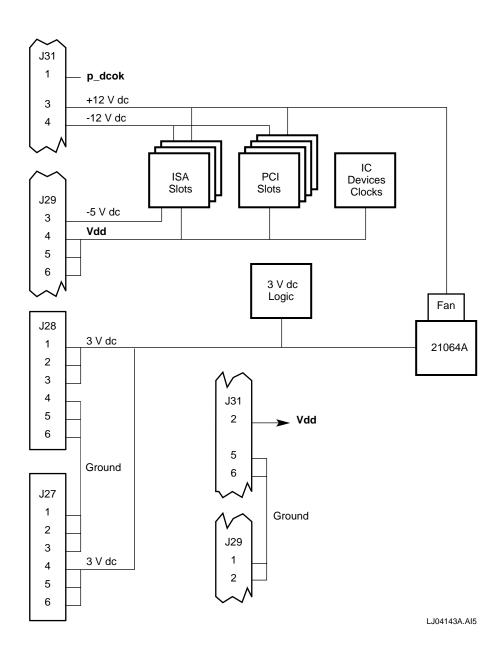
4.3 dc Power Distribution

4.3 dc Power Distribution

The AlphaPC64 derives its system power from a user-supplied, industry-standard PC power supply. The power supply must provide +12 V dc, -12 V dc, -5 V dc, **Vdd** (+5 V dc), and +3.3 V dc. The dc power is supplied through power connectors J27, J28, J29, and J31 (see Figure 4–4). Power is distributed to the board logic through dedicated power planes within the 6-layer board structure.

4.3 dc Power Distribution

Figure 4-4 dc Power Distribution



4.4 Flash ROM (System ROM)

The flash ROM, sometimes called the system ROM, is a 1MB, nonvolatile, writable ROM. After the SROM code initializes the AlphaPC64 system, flash ROM code prepares the system for booting. The flash ROM headers, structure, and access methods are described here.

4.4.1 Special Flash ROM Headers

The MAKEROM tool is used to place a special header on ROM image files. The SROM allows the flash ROM to contain several different ROM images, each with its own header. The header informs the SROM where to load the image, and whether or not it has been compressed with the MAKEROM tool. The header is optional for flash ROM containing a single image. If the header does not exist, the 1MB flash ROM is loaded and executed at physical address zero. Figure 4–5 shows the header content.

Figure 4–5 Special Header Content

31			ı	00
	Validation Patte	rn 5A5AC3C3		00
	Inverse Validation P	attern A5A53C3C		04
	Header Siz	e (Bytes)		08
	Image Ch	ecksum		00
	Image Size (Mer	mory Footprint)		10
	Decompres	sion Flag		14
	Destination Address Lower Longword			18
	Destination Address Upper Longword			10
	Reserved<31:16>	Firmware ID<15:8>	Header Rev<7:0>	20
	Flash ROM I	mage Size		24
	Optional Firmw	rare ID<31:0>		28
	Optional Firmwa	are ID<63:32>		20
	Header Checksum (e	excluding this field)		30

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Table 4–2 describes each entry in the special header.

Table 4–2 Special Header Entry Descriptions

Description		
This quadword contains a special signature pattern used to validate that the special ROM header has been located. The pattern is 5A5AC3C3A5A53C3C.		
U		
the image begins	based on the	e header size. Additional data
A header size of 3 specifications.	32 bytes imp	lies version 0 of the header
This longword is	used to verif	y the integrity of the ROM.
		SROM code to determine how l be loaded.
The decompression flag informs the SROM code whether the MAKEROM tool was used to compress the ROM image with a repeating byte algorithm. The SROM code contains routines that execute the decompression algorithm. Other compression and decompression schemes, which work independently from this scheme, may be employed.		
This quadword contains the destination address for the image. The SROM code will load the image at this address and begin execution.		
This information	facilitates in	nage boot options necessary to
	Firmware	
Firmware Name	Type	Firmware Description
Debug monitor	0	Alpha evaluation board debug monitor
Windows NT	1	Windows NT firmware
Alpha SRM	2	Alpha System Reference Manual console
	This quadword covalidate that the pattern is 5A5AC. This longword corvaries among versus when the header the image begins added to the head A header size of 3 specifications. This longword is the image size is much of the flash. The decompression the MAKEROM to with a repeating broutines that executions that executions and independently from This quadword coimage. The SROM and begin execution the firmware ID. This information is boot different operations.	This quadword contains a spe validate that the special ROM pattern is 5A5AC3C3A5A53C3. This longword contains the six varies among versions of the law when the header is located, So the image begins based on the added to the header will be ig A header size of 32 bytes improperity by the much of the flash ROM should the image size is used by the much of the flash ROM should the MAKEROM tool was used with a repeating byte algorith routines that execute the decompression and decompression and decompression independently from this scheme. This quadword contains the dimage. The SROM code will lead begin execution. The firmware ID is a byte that This information facilitates in boot different operating system. Firmware Firmware Name Type Debug monitor 0 Windows NT 1

(continued on next page)

Table 4–2 (Cont.) Special Header Entry Descriptions

Entry	Description
Header revision	The revision of the header specifications used in this header. This is necessary to provide for changes to the header specification. Version 0 headers are identified by the size of the header (32 bytes).
Flash ROM image size	The flash ROM image size reflects the size of the image as it is contained in the flash ROM.
Optional firmware ID	This optional field can be used to provide additional firmware information such as firmware revision or a character descriptive string up to 8 characters.
Header checksum	The checksum of the header. This is used to validate the presence of a header beyond the validation provided by the validation pattern.

4.4.2 Flash ROM Structure

During the power-up and initialization sequence, the AlphaPC64 always loads the first image if the BOOT_OPTION jumper J3-25/26 is not installed. Then the first image (the debug monitor) will be booted.

If jumper J3-25/26 is installed, the AlphaPC64 reads the value at location 3F of the TOY NVRAM. The AlphaPC64 uses the value found there to determine which image will be selected (see Table 4-3). The selected image is loaded and executed.

Table 4-3 Higher 512KB Flash ROM Image Selection

TOY RAM Value ¹	Firmware ID ²	Image Description
00	0	Evaluation board debug monitor firmware
01	1	Windows NT ARC firmware
02	2	Alpha SRM firmware (OpenVMS) ³
03	2	Alpha SRM firmware (Digital UNIX) ³
8 <i>n</i>	NA ⁴	SROM code will load the <i>n</i> th image from flash ROM. If <i>n</i> =0, the SROM code loads the entire flash ROM contents. If <i>n</i> =1, 2,, the SROM code loads the first image, second image, and so on.

¹Operating system type. Found at TOY RAM address 3F.

If an image is specified and is not found, the AlphaPC64 loads the first image in the flash ROM with a valid header. If no valid header is found, the entire 1MB flash image is loaded at address 0000 0000.

The following sequence of steps describes how to change the value stored in TOY RAM location 3F by using either the basic debug monitor commands or the debug monitor bootopt command.

²Found in image header.

³Note: SRM firmware is not included in the AlphaPC64 kit.

The flash ROM contains only one of these images.

⁴Not applicable.

Changing TOY RAM Location 3F—Debug Monitor bootopt Command

Use the debug monitor bootopt command to change the value in location 3F. In the example shown here, the bootopt command is used to change the value in location 3F from 0 to 1:

```
AlphaPC64> bootopt 1
Predefined bootoptions are...
  "0" "Alpha Evaluation Board Debug Monitor" "DBM"
  "1" "The Windows NT Operating System" "NT"
  "2" "OpenVMS" "VMS"
  "3" "Digital UNIX" "UNIX"
O/S type selected: "Alpha Evaluation Board Debug Monitor"
....Firmware type: "DBM Firmware"
AlphaPC64> bootopt nt 2
O/S type selected: "The Windows NT Operating System"
....Firmware type: "Windows NT Firmware"
AlphaPC64> bootopt 3
Predefined bootoptions are...
  "0" "Alpha Evaluation Board Debug Monitor" "DBM"
  "1" "The Windows NT Operating System" "NT"
  "2" "OpenVMS" "VMS"
  "3" "Digital UNIX" "UNIX"
O/S type selected: "The Windows NT Operating System"
....Firmware type: "Windows NT Firmware"
AlphaPC64>
```

- 1 Use the debug monitor bootopt command to see the image choices and note which image is selected.
- 2 Use the debug monitor bootopt nt command to change the selected image from 0 to 1.
- 3 Use the debug monitor bootopt command to verify that the selected image has changed from 0 to 1.

4.4.3 Flash ROM Access

The flash ROM can be viewed as two banks of 512KB each. At power-up, the lower 512KB bank is accessed using the address range 3 FFF8 0000 to

Setting address bit 19 will allow you to access the higher 512KB of flash ROM. Write a 1 to the register at address 800 to set address bit 19. Manually deposit a 1 to address 1 C001 0000 or enter the following command from the debug monitor:

> wb 800 1

The address range for the higher bank is 3 FFF8 0000 to 3 FFFF FFFF, the same as for the lower bank. Access is now to the higher bank and will continue until the AlphaPC64 is reset or a 0 is written to the register at address 800.

Note
The update-enable jumper must be installed from pin J16-2 to pin J16-3 to enable writing to the flash ROM. See connector J16 in Table 2–3.

Board Requirements and Parameters

This chapter describes the evaluation board power and environmental requirements, and physical board parameters.

5.1 Power Requirements

The AlphaPC64 derives its main dc power from a user-supplied, industrystandard PC power supply. The board has a total power dissipation of 96.2 W, excluding PCI and ISA devices. Table 5-1 lists the power requirements of each dc supply voltage.

The power supply must supply signal **p_dcok** to the system reset logic.

Table 5–1 Power Supply dc Current Requirements (275 MHz)

Voltage	Current	
+5 V dc	10 A (maximum)	
+3.3 V dc	10 A (maximum)	
-5 V dc	0 A	
+12 V dc	1 A (maximum)	
–12 V dc	0.1 A (maximum)	

Caution: Fan Sensor Required _

The 21064A cooling fan must have a built-in sensor that drives a signal if the airflow stops. The sensor is connected to J14.

When airflow is interrupted, the sensor signal fan_conn_l is asserted causing the signal cpu_dcok to be deasserted to the 21064A. This protects the 21064A under fan-failure conditions because the 21064A dissipates less heat when **cpu_dcok** is deasserted.

5.2 Environmental Characteristics

5.2 Environmental Characteristics

The AlphaPC64 board environmental characteristics are:

- Operating temperature range of 10°C to 40°C (50°F to 104°F)
- Storage temperature range of -55°C to 125°C (-67°F to 257°F)

5.3 Physical Board Parameters

The AlphaPC64 board consists of a 6-layer printed-wiring board. The board is populated with integrated circuit packages together with supporting active and passive components. The AlphaPC64 is a baby-AT-size board with the following dimensions:

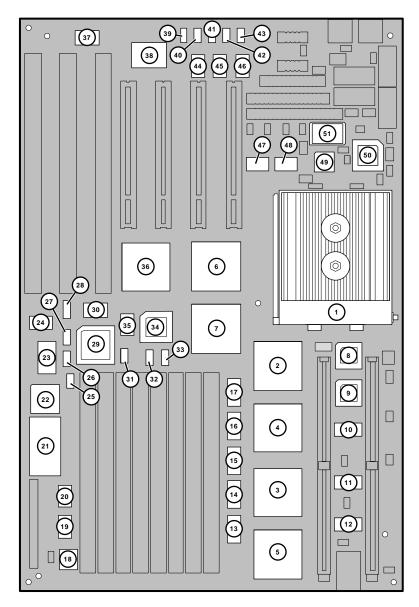
- Width: 22.1 cm (8.7 in \pm 0.0005 in)
- Length: $33.0 \text{ cm} (13.0 \text{ in} \pm 0.0005 \text{ in})$

The board can be used in certain desktop systems that have adequate clearance for the 21064A heat sink. All ISA and PCI expansion slots are usable in standard desktop or deskside enclosures.

Figure 5–1 shows the board and component outlines and identifies key components. The components are described in Table 5-2. Refer to Chapter 2 for jumper and connector locations.

5.3 Physical Board Parameters

Figure 5-1 Board Component Layout



LJ-04460.AI5

5.3 Physical Board Parameters

Table 5–2 Board Component Descriptions

Number	Device	Component Description
1	U36	Alpha 21064A-275 microprocessor—431 PGA, 275 MHz
2	U24	DECchip 21071-BA0, 208-pin PQFP, ASIC
3	U8	DECchip 21071-BA1, 208-pin PQFP, ASIC
4	U13	DECchip 21071-BA2, 208-pin PQFP, ASIC
5	U2	DECchip 21071-BA3, 208-pin PQFP, ASIC
6	U35	DECchip 21071-DA, 208-pin PQFP, ASIC
7	U31	DECchip 21071-CA, 208-pin PQFP, ASIC
8, 9	U25, 17	PALCE16V8-5, 5-ns, 125-mA, 20-pin PLCC
10, 11, 12	U14, U9, U5	74FCT162244ETPV—48 SSOP
13, 14, 15, 16, 17	U4, U7, U11, U12, U16	74ABT162244—48-pin SSOP, 16-bit buffer/driver
18	U1	$64 \text{K} \times 1 \text{ CMOS}$ OTP serial ROM (initialization code)
19, 20	U3, U6	74F244 buffer/line driver
21	U10	Dallas Semiconductor DS1287—24-pin DIP, real- time clock and 50-byte RAM with crystal
22	U15	Intel N8242PC/PHOENIX/1991 mouse and keyboard controller, 44-pin PLCC
23	U19	E28F008SA-120, 40-pin TSOP, 1MX8 CMOS flash ROM, 120 ns
24	U28	74F245 transceiver
25	U18	74LS05 inverter gate
26	U20	74F14 trigger, SOIC
27	U26	74F02D NOR gate
28	U32	74F257 data selector/multiplexer
29	U27	PLD, MACH210–20, 20-ns, 180-mA, 44-pin PLCC interrupt controller
30	U33	14.3-MHz crystal oscillator, PCI-to-ISA bridge (SIO) oscillator
31	U21	74F04 hex inverter

(continued on next page)

5.3 Physical Board Parameters

Table 5–2 (Cont.) Board Component Descriptions

Number	Device	Component Description
32, 33	U22, U23	74F08 AND gate
34	U30	PALCE22V10H-25JC, 28-pin PLCC, 25 ns
35	U29	74ACT244
36	U34	S82378ZB—208-pin PQFP, PCI-to-ISA bridge chip
37	U47	24-MHz crystal oscillator
38	U43	PC87312VF combination diskette controller chip—100-pin PQFP
39, 41, 43	U48, U50, U52	SN75189 receiver
40, 42	U49, U51	SN75188 driver
44, 45	U44, U45	74F245 transceiver
46	U46	74F244 buffer/line driver
47, 48	U37, U38	IDC FCT805CT—20-pin SOIC
49	U39	AMCC S4402 PLL—28-pin PLCC
50	U40	TriQuint TQ2061—28-pin PLCC, PLL 500-MHz to 700-MHz output
51	U41	27.50-MHz crystal oscillator

Supporting Vendor Products

To obtain components and accessories that are not included with your AlphaPC64 motherboard, Digital Equipment Corporation suggests the following vendors. In doing so, Digital does not warrant these components or guarantee that they will function in all configurations.

A.1 Products Included

The following products are included in the AlphaPC64 motherboard kit.

Alpha microprocessor clock solution. Components available from:

TriQuint Semiconductor 2300 Owen Street Santa Clara CA 95054 Phone: 408.982.0900 ext 142

FAX: 408.982.0222

NEL Frequency (crystal oscillator source)

CPU Frequency	Oscillator Frequency	TriQuint PLL Part Number
21064A-200	40.0 MHz	TQ2060 (optional)
21064A-233	46.66 MHz	TQ2060 (optional)
21064A-275	27.5 MHz	TQ2061 (included)

Heat sink and fan solution. Components included: heat sink, GRAFOIL pad, 2 hex nuts, heat sink clips, 60-mm fan, fan guard, and 4 screws. Components available from:

United Machine and Tool Design River Road Fremont NH 03044 Phone 603.642.5040 FAX 603.642.5819

A.1 Products Included

• L2 cache SIMMs (21A02-A3 does not include cache SIMMs)

Cache Size	SIMM Configuration	Qty	Vendor/Part Number
512KB, 15 ns ¹	32K × 96	2	Digital PN, 21A02-M1 Motorola PN, MCM96AA32SG15
2MB, 12 ns ²	128K × 92	2	Digital PN, 21A02-M2 Motorola PN, MCM92AA128SG12 Micron PN, MBDLS12896G-12

A.2 Products Not Included

The following products are not included in the AlphaPC64 motherboard kit.

- DRAM system memory—70 ns DRAM SIMMs (5 V, 72 pin) $1M \times 36$, $2M \times 36$, $4M \times 36$, $8M \times 36$, $16M \times 36$. DRAM SIMMs must include provisions for parity.
- Power supply—+3.3 V, +5 V, -5 V, +12 V, -12 V, available from:

Emacs Electronics USA, Inc. 1410 Gail Borden Place C-4

El Paso TX 79935 Phone: 915.599.2688

Part number: AP2-5300F (300 W)

Autec Power System 69 Moreland Road Simi Valley CA 93065 Phone: 805.522.0888

Part number: PCB-3330-1010-D (275 W)

• Enclosure

Axxion Group 7801 Trade Center Avenue

El Paso TX 79912 Phone: 915.877.3990 Part number: DL09-P51

Technical Support and Ordering Information

B.1 Technical Support

If you need technical support or help deciding which literature best meets your needs, call the Digital Semiconductor Information Line:

United States and Canada 1-800-332-2717 Outside North America +1-508-628-4760

B.2 Ordering Digital Semiconductor Products

To order the AlphaPC64 evaluation board and related products, contact your local distributor.

You can order the following semiconductor products from Digital:

Product	Order Number
Alpha 21064A-200 Microprocessor	21064-AB
Alpha 21064A-233 Microprocessor	21064-BB
Alpha 21064A-275 Microprocessor	21064-DB
Alpha 21064PC-275 Microprocessor for PC products	21064-P1
AlphaPC64 P3 Motherboard	21A02-A3
AlphaPC64 P3 Motherboard with 2MB, 12-ns L2 Cache SIMMs	21A02-A4
AlphaPC64 P3 Motherboard with 512KB, 15-ns L2 Cache SIMMs	21A02-A5
AlphaPC64 Evaluation Board 275-MHz Kit	21A02-03
AlphaPC64 Evaluation Board Design Kit	QR-21A02-13
512KB, 15-ns L2 Cache SIMM for AlphaPC64	21A02-M1

B.2 Ordering Digital Semiconductor Products

Product	Order Number
2MB, 12-ns L2 Cache SIMM for AlphaPC64	21A02-M2
Heat Sink Assembly	2106H-AA
Alpha 21064 Evaluation Board Design Package	21A01-13

B.3 Ordering Associated Literature

The following table lists some of the available Digital Semiconductor literature. For a complete list, contact the Digital Semiconductor Information Line.

Title	Order Number		
Alpha 21064 and Alpha 21064A Documentation			
Alpha AXP Architecture Handbook	EC-QD2KA-TE		
Alpha 21064A Microprocessor Product Brief	EC-QH0RA-TE		
Alpha 21064A-233, -275 Microprocessor Data Sheet	EC-QFGKA-TE		
Alpha 21064 and Alpha 21064A Microprocessors Hardware Reference Manual	EC-Q9ZUB-TE		
SPICE Models for Alpha Microprocessors and Peripheral Chips: An Application Note	EC-QA4XB-TE		
Alpha Microprocessor Motherboard Software Documentation			
PALcode for Alpha Microprocessors System Design Guide	EC-QFGLB-TE		
Alpha Microprocessors Evaluation Board Debug Monitor User's Guide	EC-QHUVB-TE		
Alpha Microprocessors Evaluation Board Software Design Tools User's Guide	EC-QHUWA-TE		
Alpha Microprocessors SROM Mini-Debugger User's Guide	EC-QHUXA-TE		
Alpha Microprocessors Evaluation Board Windows NT 3.51 Installation Guide	EC-QLUAB-TE		
Alpha Evaluation Boards Software Developer's Kit Read Me First	EC-QERSC-TE		

B.3 Ordering Associated Literature

Title	Order Number		
Associated DECchip Documentation			
DECchip 21071 and DECchip 21072 Core Logic Chipsets Product Brief	EC-QH0QA-TE		
DECchip 21071 and DECchip 21072 Core Logic Chipsets Data Sheet	EC-QAEMA-TE		
Designing a Memory/Cache Subsystem for the DECchip 21064 Microprocessor: An Application Note	EC-N0301-72		
Designing a System with the DECchip 21064 Microprocessor: An Application Note	EC-N0107-72		
Calculating a System I/O Address for the DECchip 21064 Evaluation Board: An Application Note	EC-N0567-72		

B.4 Ordering Third-Party Documentation

B.4 Ordering Third-Party Documentation

You can order the following documentation directly from the vendor:

Documentation	Order Number
82420/82430 PCIset ISA and EISA Bridges (includes 82378ZB SIO)	Intel No 290483
PC87311/PC87312 (Super I/O™ II/III) Floppy Disk Controller with Dual UARTs, Parallel Port, and IDE Interface	National Semiconductor No 11362
UPI-41AH/42AH Universal Peripheral Interface 8-Bit Slave Microcontroller	Intel No 210393
Peripheral Components	Intel No 296467
Flash Memory	Intel No 210830
PCI Local Bus Specification, Rev 2.0	Contact PCI Special Interest Group
PCI System Design Guide	Contact PCI Special Interest Group
Hardware Compatability List	Contact Microsoft's Customer Service representatives at 1-800-426-9400 or, access CompuServe Information Systems in Library 1 of the WINNT forum (GO WINNT) or Library 17 of the MSWIN32 forum (GO MSWIN32).

Vendor Addresses

Intel Corporation 2200 Mission College Boulevard PO Box 58119 Santa Clara CA 95052-8119 1-800-548-4725

National Semiconductor 2900 Semiconductor Drive PO Box 58090 Santa Clara CA 95052-8090 1-800-272-9959

PCI Special Interest Group M/S HF3-15A 5200 NE Elam Young Parkway Hillsboro OR 97124-6497 1-503-696-2000

Warranty Registration Information

To register your AlphaPC64 motherboard and be notified of changes and updates, as well as new kits and products available from Digital Equipment Corporation, please complete the registration card included in the kit, or send the following information to the address listed below:

Name Company Address Phone number FAX phone number Product purchased Serial number Date purchased

Mail the information to:

Digital Equipment Corporation Marketing/Product Updates HLO2-2/M9 77 Reed Road Hudson, MA 01749-2895

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